DATA SHEET

74ABT16827A

74ABTH16827A

20-bit buffer/line driver, non-inverting (3-State)

Product specification
Supersedes data of 1998 Feb 27

2002 Dec 17

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20-bit buffer/line driver, non-inverting (3-State)

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74ABT16827A
74ABTH16827A

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FEATURES

- Multiple V_{CC} and GND pins minimize switching noise
- Live insertion/extraction permitted
- 3-State output buffers
- Power-up 3-State
- 74ABTH16827A incorporates bus-hold data inputs which eliminate the need for external pull-up resistors to hold unused inputs
- Output capability: +64 mA / −32 mA
- Latch-up protection exceeds 500 mA per Jedec Std 17
- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200 V per Machine Model

DESCRIPTION

The 74ABT16827A high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT16827A 20-bit buffers provide high performance bus interface buffering for wide data/address paths or buses carrying parity. They have NOR Output Enables (n$\overline{OE}$1, n$\overline{OE}$2) for maximum control flexibility.

Two options are available, 74ABT16827A which does not have the bus-hold feature and 74ABTH16827A which incorporates the bus-hold feature.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T_{amb} = 25 °C; GND = 0 V	TYPICAL	UNIT
t_{PLH} t_{PHL}	Propagation delay nAx to nYx	C_L = 50 pF; V_{CC} = 5 V	1.7 1.4	ns
C_{IN}	Input capacitance	V_I = 0 V or V_{CC}	4	pF
C_{OUT}	Output capacitance	V_O = 0 V or V_{CC}; 3-State	6	pF
I_{CCZ}	Quiescent supply current	Outputs disabled; V_{CC} = 5.5 V	500	μA
I_{CCL}		Outputs LOW; V_{CC} = 5.5 V	9	mA

ORDERING INFORMATION

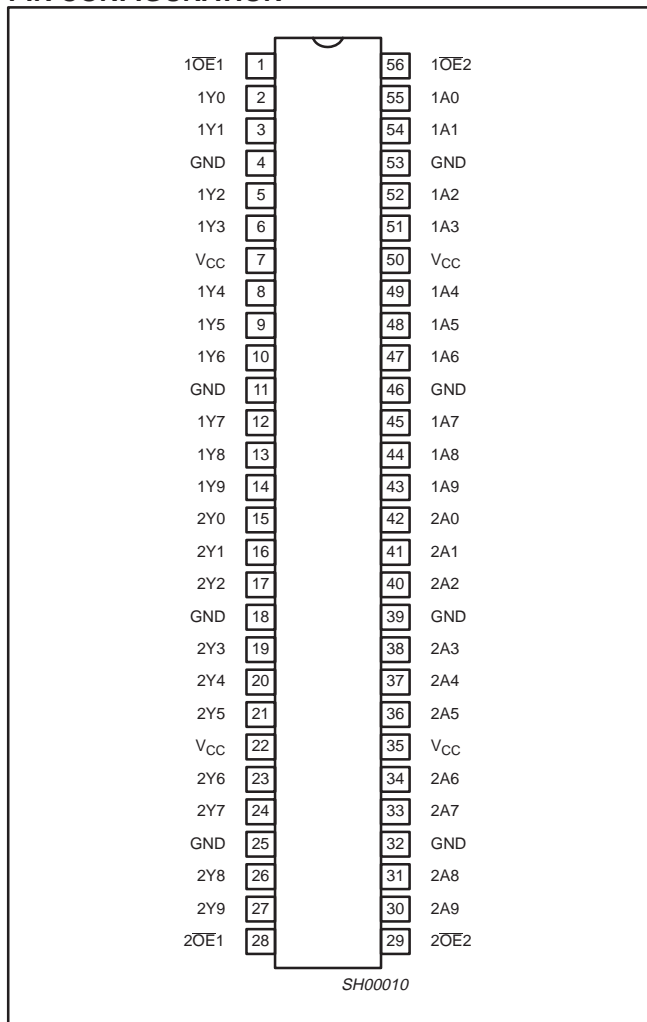| PACKAGES	TEMPERATURE RANGE	PART NUMBER	DWG NUMBER
56-Pin Plastic SSOP Type III	−40 °C to +85 °C	74ABT16827ADL	SOT371-1
56-Pin Plastic TSSOP Type II	−40 °C to +85 °C	74ABT16827ADGG	SOT364-1
56-Pin Plastic TSSOP Type II	−40 °C to +85 °C	74ABTH16827ADGG	SOT364-1

PIN DESCRIPTION

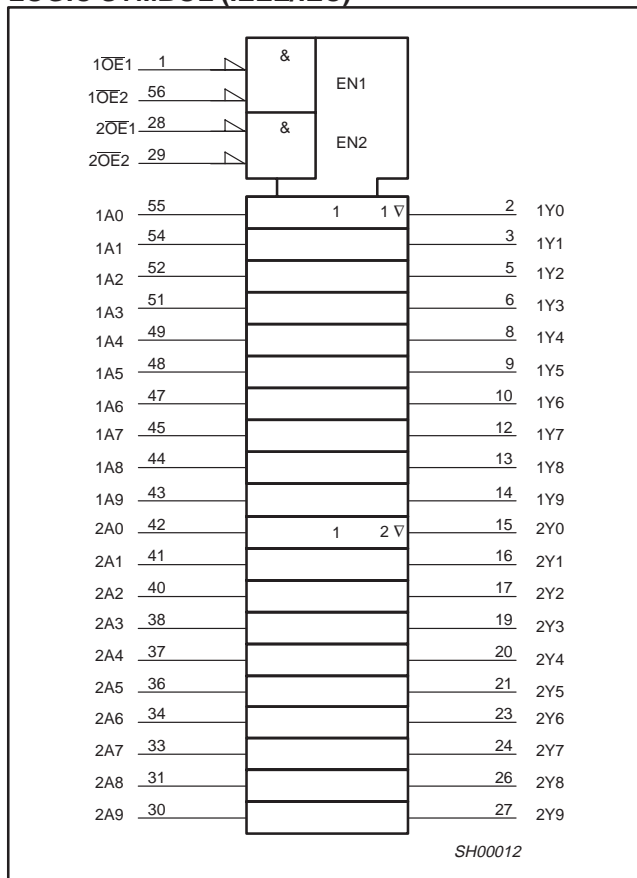| PIN NUMBER	SYMBOL	FUNCTION
55, 54, 52, 51, 49, 48, 47, 45, 44, 43, 42, 41, 40, 38, 37, 36, 34, 33, 31, 30	1A0 – 1A9 2A0 – 2A9	Data inputs
2, 3, 5, 6, 8, 9, 10, 12, 13, 14, 15, 16, 17, 19, 20, 21, 23, 24, 26, 27	1Y0 – 1Y9 2Y0 – 2Y9	Data outputs
1, 56, 28, 29	1$\overline{OE}$0, 1$\overline{OE}$1 2$\overline{OE}$0, 2$\overline{OE}$1	Output enable inputs (active-LOW)
4, 11, 18, 25, 32, 39, 46, 53	GND	Ground (0 V)
7, 22, 35, 50	V_{CC}	Positive supply voltage

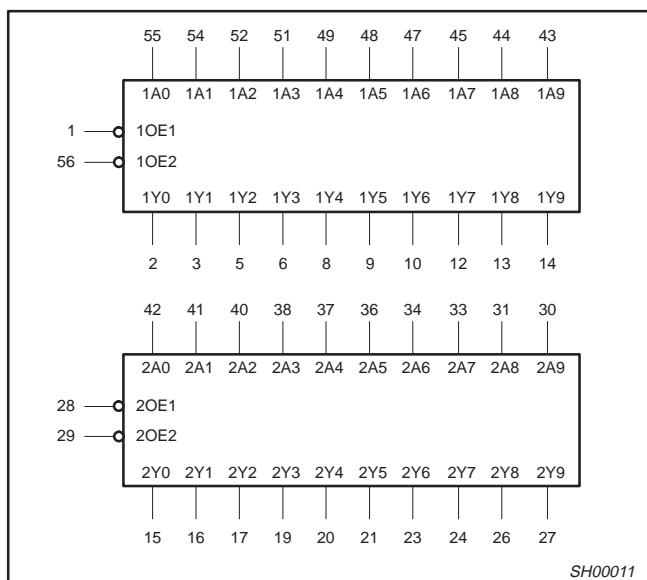## 20-bit buffer/line driver, non-inverting (3-State)

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PIN CONFIGURATION

1$\overline{OE}$1	1		56	1$\overline{OE}$2
1Y0	2		55	1A0
1Y1	3		54	1A1
GND	4		53	GND
1Y2	5		52	1A2
1Y3	6		51	1A3
V_{CC}	7		50	V_{CC}
1Y4	8		49	1A4
1Y5	9		48	1A5
1Y6	10		47	1A6
GND	11		46	GND
1Y7	12		45	1A7
1Y8	13		44	1A8
1Y9	14		43	1A9
2Y0	15		42	2A0
2Y1	16		41	2A1
2Y2	17		40	2A2
GND	18		39	GND
2Y3	19		38	2A3
2Y4	20		37	2A4
2Y5	21		36	2A5
V_{CC}	22		35	V_{CC}
2Y6	23		34	2A6
2Y7	24		33	2A7
GND	25		32	GND
2Y8	26		31	2A8
2Y9	27		30	2A9
2$\overline{OE}$1	28		29	2$\overline{OE}$2

SH00010

LOGIC SYMBOL

SH00011

LOGIC SYMBOL (IEEE/IEC)

SH00012

FUNCTION TABLE

INPUTS		OUTPUTS	OPERATING MODE
n$\overline{OE}$x	nAx	nYx	
L	L	L	Transparent
L	H	H	Transparent
H	X	Z	High impedance

X = Don't care
Z = High impedance "off" state
H = HIGH voltage level
L = LOW voltage level

20-bit buffer/line driver, non-inverting (3-State)

LOGIC DIAGRAM

SH00013
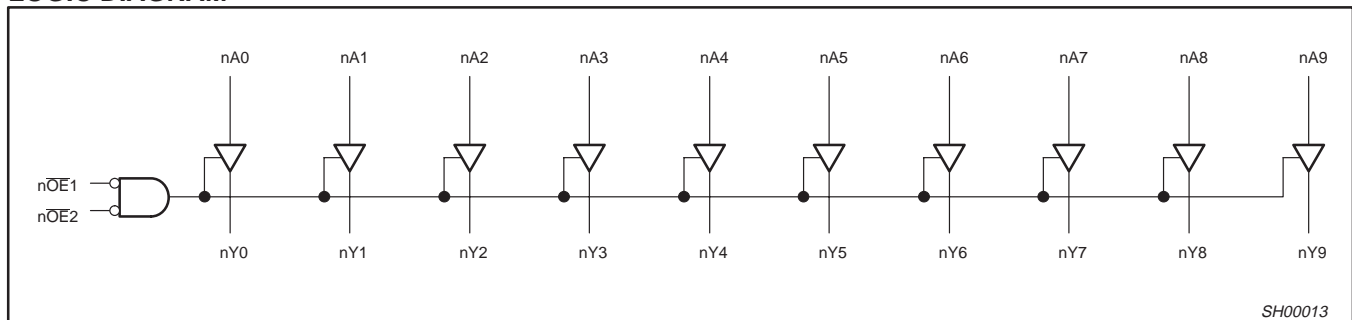
ABSOLUTE MAXIMUM RATINGS[1, 2]

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		−0.5 to +7.0	V
I_{IK}	DC input diode current	$V_I < 0$ V	−18	mA
V_I	DC input voltage[3]		−1.2 to +7.0	V
I_{OK}	DC output diode current	$V_O < 0$ V	−50	mA
V_{OUT}	DC output voltage[3]	Output in Off or HIGH state	−0.5 to +5.5	V
I_{OUT}	DC output current	Output in LOW state	128	mA
		Output in HIGH state	−64	mA
T_{stg}	Storage temperature range		−65 to 150	°C

NOTES:
1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.
3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		MIN	MAX	
V_{CC}	DC supply voltage	4.5	5.5	V
V_I	Input voltage	0	V_{CC}	V
V_{IH}	HIGH-level input voltage	2.0	–	V
V_{IL}	LOW-level Input voltage	–	0.8	V
I_{OH}	HIGH-level output current	–	−32	mA
I_{OL}	LOW-level output current	–	64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	ns/V
T_{amb}	Operating free-air temperature range	−40	+85	°C

20-bit buffer/line driver, non-inverting (3-State)

DC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITIONS		T_{amb} = +25 °C			T_{amb} = −40 °C to +85 °C		UNIT
				MIN	TYP	MAX	MIN	MAX	
V_{IK}	Input clamp voltage	V_{CC} = 4.5 V; I_{IK} = −18 mA			−0.9	−1.2		−1.2	V
V_{OH}	HIGH-level output voltage	V_{CC} = 4.5 V; I_{OH} = −3 mA; V_I = V_{IL} or V_{IH}		2.5	2.9		2.5		V
		V_{CC} = 5.0 V; I_{OH} = −3 mA; V_I = V_{IL} or V_{IH}		3.0	3.4		3.0		V
		V_{CC} = 4.5 V; I_{OH} = −32 mA; V_I = V_{IL} or V_{IH}		2.0	2.4		2.0		V
V_{OL}	LOW-level output voltage	V_{CC} = 4.5 V; I_{OL} = 64 mA; V_I = V_{IL} or V_{IH}			0.42	0.55		0.55	V
I_I	Input leakage current	V_{CC} = 5.5 V; V_I = GND or 5.5 V			±0.01	±1.0		±1.0	µA
I_I	Input leakage current 74ABTH16827A	V_{CC} = 5.5 V; V_I = 5.5 V			0.01	1		1	µA
		V_{CC} = 5.5 V; V_I = V_{CC} or GND	Control pins		±0.01	±1		±1	µA
		V_{CC} = 5.5 V; V_I = V_{CC}	Data pins[4]		0.01	1		1	µA
		V_{CC} = 5.5 V; V_I = 0			−1	−3		−5	µA
I_{HOLD}	Bus Hold current A inputs[5] 74ABTH16827A	V_{CC} = 4.5 V; V_I = 0.8 V		35			35		µA
		V_{CC} = 4.5 V; V_I = 2.0 V		−75			−75		
		V_{CC} = 5.5 V; V_I = 0 to 5.5 V		±800					
I_{OFF}	Power-off leakage current	V_{CC} = 0.0 V; V_O = 4.5 V; V_I = 0 V or 5.5 V			±5.0	±100		±100	µA
I_{PU}/I_{PD}	Power-up/down 3-State output current[3]	V_{CC} = 2.1 V; V_O = 0.5 V; V_I = GND or V_{CC}; V_{OE} = Don't care			±5.0	±50		±50	µA
I_{OZH}	3-State output High current	V_{CC} = 5.5 V; V_O = 2.7 V; V_I = V_{IL} or V_{IH}			1.0	10		10	µA
I_{OZL}	3-State output Low current	V_{CC} = 5.5 V; V_O = 0.5 V; V_I = V_{IL} or V_{IH}			−1.0	−10		−10	µA
I_{CEX}	Output HIGH leakage current	V_{CC} = 5.5 V; V_O = 5.5 V; V_I = GND or V_{CC}			1.0	50		50	µA
I_O	Output current[1]	V_{CC} = 5.5 V; V_O = 2.5 V		−50	−70	−180	−50	−180	mA
I_{CCH}	Quiescent supply current	V_{CC} = 5.5 V; Outputs HIGH, V_I = GND or V_{CC}			0.5	1		1	mA
I_{CCL}		V_{CC} = 5.5 V; Outputs LOW, V_I = GND or V_{CC}			9	19		19	mA
I_{CCZ}		V_{CC} = 5.5 V; Outputs 3-State; V_I = GND or V_{CC}			0.5	1		1	mA
ΔI_{CC}	Additional supply current per input pin[2]	V_{CC} = 5.5 V; one input at 3.4 V, other inputs at V_{CC} or GND			0.2	1		1	mA

NOTES:
1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
2. This is the increase in supply current for each input at 3.4 V.
3. This parameter is valid for any V_{CC} between 0 V and 2.1 V with a transition time of up to 10 msec. From V_{CC} = 2.1 V to V_{CC} = 5 V ± 10% a transition time of up to 100 µsec is permitted.
4. Unused pins at V_{CC} or GND.
5. This is the bus hold overdrive current required to force the input to the opposite logic state.

AC CHARACTERISTICS
GND = 0 V, t_R = t_F = 2.5 ns, C_L = 50 pF, R_L = 500 Ω

| SYMBOL	PARAMETER	WAVEFORM	T_{amb} = +25 °C V_{CC} = +5.0 V			T_{amb} = −40 °C to +85 °C V_{CC} = +5.0 V ±0.5 V		UNIT
			MIN	TYP	MAX	MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay nAx to nYx	1	1.0 0.6	1.7 1.4	2.4 2.0	1.0 0.6	2.7 2.3	ns
t_{PZH} t_{PZL}	Output enable time to HIGH and LOW level	2	1.0 1.0	3.0 3.0	4.1 4.0	1.0 1.0	5.0 5.0	ns
t_{PHZ} t_{PLZ}	Output disable time from HIGH and LOW level	2	2.0 1.6	3.2 2.4	4.3 3.2	2.0 1.6	5.0 3.5	ns

20-bit buffer/line driver, non-inverting (3-State)
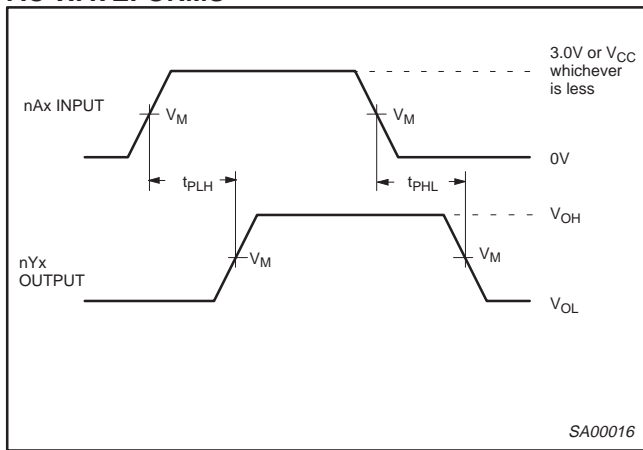
AC WAVEFORMS

Waveform 1. Input (nAx) to Output (nYx) Propagation Delays
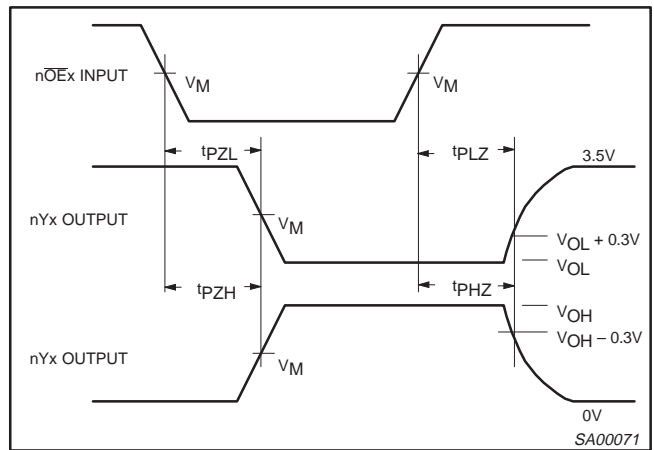
Waveform 2. 3-State Output Enable and Disable Times

TEST CIRCUIT AND WAVEFORM

Test Circuit for 3-State Outputs

$V_M = 1.5V$
Input Pulse Definition

SWITCH POSITION

TEST	SWITCH
t_{PLZ}	closed
t_{PZL}	closed
All other	open

DEFINITIONS

R_L = Load resistor; see AC CHARACTERISTICS for value.

C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

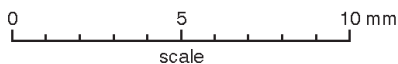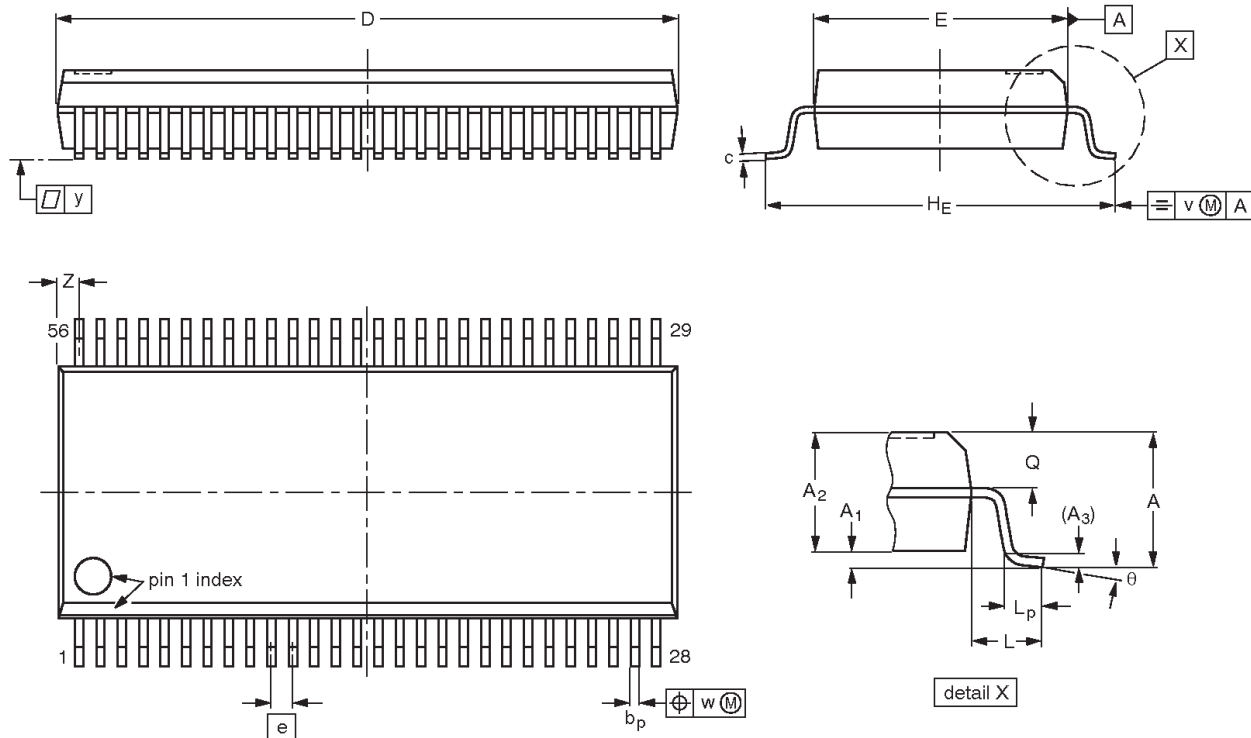| FAMILY	INPUT PULSE REQUIREMENTS				
	Amplitude	Rep. Rate	t_W	t_R	t_F
74ABT/H16	3.0V	1MHz	500ns	2.5ns	2.5ns

SA00018

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20-bit buffer/line driver, non-inverting (3-State)

74ABT16827A
74ABTH16827A

SSOP56: plastic shrink small outline package; 56 leads; body width 7.5 mm

SOT371-1

pin 1 index

detail X

DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A₁	A₂	A₃	bₚ	c	D[1]	E[1]	e	H_E	L	Lₚ	Q	v	w	y	Z[1]	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	18.55 18.30	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

Note

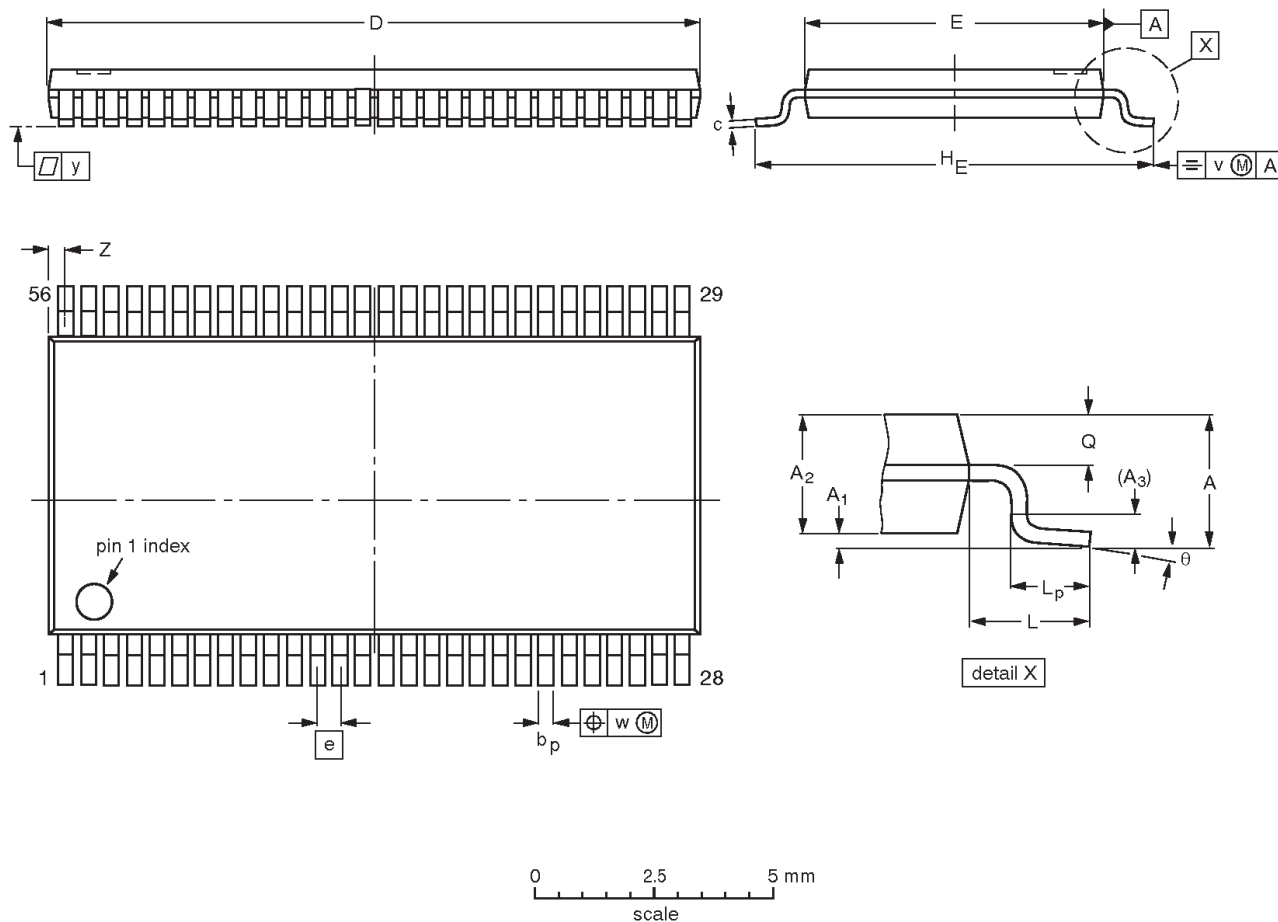1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ		
SOT371-1		MO-118			~~95-02-04~~ 99-12-27

20-bit buffer/line driver, non-inverting (3-State)

74ABT16827A
74ABTH16827A

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm

SOT364-1

DIMENSIONS (mm are the original dimensions).

UNIT	A max.	A₁	A₂	A₃	b_p	c	D⁽¹⁾	E⁽²⁾	e	H_E	L	L_p	Q	v	w	y	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1.0	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT364-1		MO-153				~~95-02-10~~ 99-12-27

20-bit buffer/line driver, non-inverting (3-State)

74ABT16827A
74ABTH16827A

REVISION HISTORY

Rev	Date	Description
_2	20021217	**Product data (9397 750 10858); ECN 853-1824 29295 of 12 December 2002. Supersedes data of 27 February 1998 (9397 750 03504).** Modifications: • Ordering information table: remove "North America" column; remove 74ABTH16827ADL package offering.
_1	19980227	**Product specification (9397 750 03504). ECN 853-1824 19025 of 27 February 1998.**

20-bit buffer/line driver, non-inverting (3-State)	74ABT16827A
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Data sheet status

Level	Data sheet status [1]	Product status [2] [3]	Definitions
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Contact information

For additional information please visit
http://www.semiconductors.philips.com.   Fax: **+31 40 27 24825**

For sales offices addresses send e-mail to:
sales.addresses@www.semiconductors.philips.com.

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